

**AGENDA**  
**P-2.5 COMMITTEE FOR TANTALUM, NIOBIUM, ALUMINUM CHIP**  
**CAPACITORS**  
**WEDNESDAY, Apr 28, 2010**  
**Orlando, Fl.**

**I. COMMITTEE ORGANIZATION AND PROCEDURE**

- 1. Membership and attendance –**
- 2. Approval of agenda –**
- 3. Approval of minutes –**
- 4. Correspondence -**

**II. OLD BUSINESS**

- 1. Reports**
  - a. S-1 Passive Component Steering Committee –**
  - b. Government Specifications and standards (DSCC representative) –**
  - c. AEC Q200 Subcommittee –**
- 2. Review of Current Active Specifications**
  - a. 535BAAC molded Chip Specification**
  - b. EIA – 809 Applications Guide**
  - c. EIA/IS- 717 Qualification Spec**
  - d. EIA-757 Visual and Mechanical Guide**
  - e. EIA-953 Polymer Tantalum Specifications**
- 3. Review of Current PNs to stay Active**
  - a. PN 5138 – MicroMini Design**
  - b. PN 5137 – Facedown Design**
  - c. PN 5100 – EIA-757 Revision**
  - d. PN 5098 – EIA-809 Revision**
  - e. PN 5097 – IS-717A Update**
- 4. Review of PN 5097 Status**
- 5. Review of Current Component Bulletins**
  - a. Shelf life of tantalums**
  - b. Correct Orientation of Tantalum and MLC Capacitors in EIA-481**
- 6. Status of Archive Specs:**
  - a. 535BAAE – Molded Ta Chips Low ESR**
  - b. 535BAAD – Molded Ta Chips Protected, Extended Range**
- 7. Draft of paragraphs to describe the contents of active specs.**

### **III. NEW BUSINESS**

- 1. List of proposed specification actions**
  - a. Specs we need to revise**
  - b. other specs we need to have**
  
- 2. Component Bulletins**
  - a. New CB's needed? –**
  
- 3. Environmental Compliance Benchmarking**
  - a. Annual 3<sup>rd</sup> party test reports for banned and restricted substances.**
  - b. Materials declarations using IPC 1752, Compliance Connect, IMDS.**
  - c. BOM level environmental compliance system.**
  
- 4. DRC Response to concerns.**
  
- 5. Other New Business -**

### **IV. ADJOURNMENT –**

**62420:4/10**